

# **SHOULDER**

# SHOULDER ELECTRONICS LIMITED

# SPECIFICATION FOR APPROVAL

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CUSTOMER PRODUCT MODEL NO PREPARED APPROVED	产型编	品: 号: 制:		ngyu iating		-4	核: 期:	York 2007-05-08	
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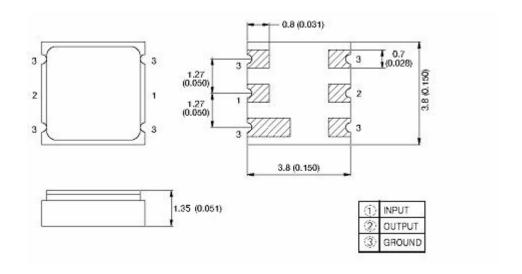
工厂地址: 江苏无锡市滨湖经济技术开发区高运路 115 号

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# 1. Package Dimension



# 2. Marking

# **HD F4818**

1.Color: Black or Blue

2.886: Center Frequency(MHz)

## 3.Performance

### 3.1Application

Low-Loss SAW Filter of cordless system.

Center Frequency:886 MHz

### 3.2Maximum Rating

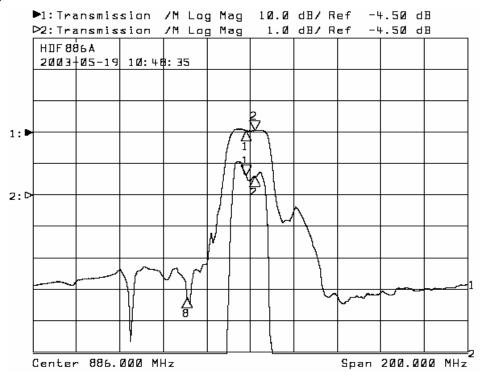
Operation Temperature Range	-10°C to +50°C
Storage Temperature Range	-40°C to +85°C
DC. Permissive Voltage	0 V DC. max.
Maximum Input Power	5dBm

#### 3.3 Electronic Characteristics

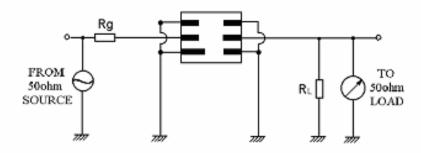
Item	Specification					
Center Frequency(fo)	886 MHz					
Insertion Loss(dB)						
1.)884-888 MHz	4.5max					
2.)840-846 MHz	40 min					
3.)862-867 MHz	30 min					
4.)905-910 MHz	20 min					
5.)926-933MHz	40 min					
Ripple deviation (884-888MHz)(dB)	1.5max					
Input/output Impedance(Nominal)	50 Ω					

Operating Temperature Range	0°C to +50°C

#### 3.4 Frequency Characteristics



#### 3.5 Test Circuit



#### 4. ENVIRONMENTAL CHARACTERISTICS

#### 4-1 Temperature cycling

Subject the device to a low temperature of  $-40^{\circ}\text{C}$  for 30 minutes. Following by a high temperature of  $+25^{\circ}\text{C}$  for 5 Minutes and a higher temperature of  $+85^{\circ}\text{C}$  for 30 Minutes. Then release the device into the room conditions for 1 to 2 hours prior to the measurement. It shall meet the specifications in table 1.

#### 4-2 Resistance to solder heat

Submerge the device terminals into the solder bath at  $260^{\circ}\text{C} \pm 5^{\circ}\text{C}$  for  $10\pm 1$  sec. Then release the device into the room conditions for 4 hours. It shall meet the

specifications in table 1.

#### 4-3 Solderability

Submerge the device terminals into the solder bath at  $245^{\circ}$ C  $\pm 5^{\circ}$ C for 5s, More than 95% area of the soldering pad must be covered with new solder. It shall meet the specifications in table 1.

#### 4-4 Mechanical shock

Drop the device randomly onto the concrete floor from the height of 1 m 3 times. the filter shall fulfill the specifications in table 1.

#### 4-5 Vibration

Subject the device to the vibration for 2 hour each in x,y and z axes with the amplitude of 1.5 mm at 10 to 55 hz. The filter shall fulfill the specifications in table 1.

#### 5. REMARK

#### 5.1 Static voltage

Static voltage between signal load & ground may cause deterioration &destruction of the component. Please avoid static voltage.

#### 5.2 Ultrasonic cleaning

Ultrasonic vibration may cause deterioration & destruction of the component. Please avoid ultrasonic cleaning

#### 5.3 Soldering

Only leads of component may be soldered. Please avoid soldering another part of component.

# 7. Packing

#### 7.1 Dimensions

(1) Carrier Tape: Figure 1

(2) Reel: Figure 2

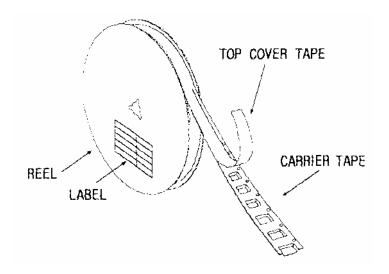
(3) The product shall be packed properly not to be damaged during transportation and storage.

#### 7.2 Reeling Quantity

1000 pcs/reel 7" 3000 pcs/reel 13"

### 7.3 Taping Structure

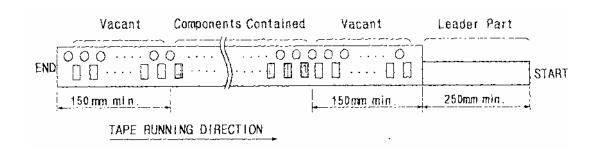
(1) The tape shall be wound around the reel in the direction shown below.



### (2) Label

Device Name	
User Product Name	
Quantity	
Lot No.	

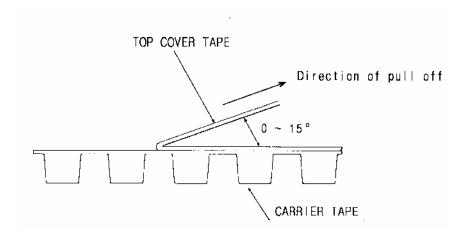
(3) Leader part and vacant position specifications.



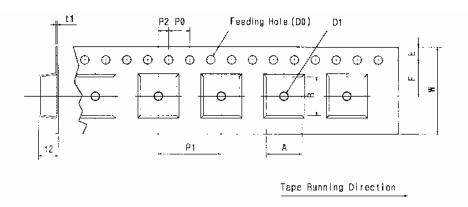
# 8. TAPE SPECIFICATIONS

- 8.1 Tensile Strength of Carrier Tape: 4.4N/mm width
- 8.2 Top Cover Tape Adhesion (See the below figure)
  - (1) pull off angle: 0~15°
  - (2) speed: 300mm/min.

# (3) force: 20~70g



[Figure 1] Carrier Tape Dimensions



[Unit:mm]

W	F	Е	P0	P1	P2	D0	D1	t1	t2	Α	В
12.00	5.50	1.75	4.00	8.00	2.00	Ø1.50	Ø1.0	0.25	1.65	4.04	4.10
±0.30	±0.10	±0.10	±0.10	±0.10	±0.10	Ø1.30	$\pm 0.25$	±0.05	±0.10	±0.10	±0.10

[Figure 2]

